

### **Product Change Notification / CENO-21UTEV408**

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27-Oct-2022

### **Product Category:**

Crypto Authentication

### **PCN Type:**

Manufacturing Change

### **Notification Subject:**

CCB 5141 Final Notice: Qualification of MTAI as an additional final test site for selected ATECC108A-SSxxx-x, ATECC508A-SSxxx-x, ATECC608A-SSxxx-x, ATECC608B-SSxxx-x and ATSHA204A-SSxxx-x device families available in 8L SOIC (3.90mm) package.

#### **Affected CPNs:**

CENO-21UTEV408\_Affected\_CPN\_10272022.pdf CENO-21UTEV408\_Affected\_CPN\_10272022.csv

#### **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MTAI as an additional final test site for selected ATECC108A-SSxxx-x, ATECC508A-SSxxx-x, ATECC608A-SSxxx-x, ATECC608B-SSxxx-x and ATSHA204A-SSxxx-x device families available in 8L SOIC (3.90mm) package.

#### **Pre and Post Change Summary:**

Dro Chango	Doot Change
Pre Change	Post Change

Final To	est Site	ASE Advanced Semiconductor (Shanghai) Co., Ltd	ASE Advanced Semiconductor (Shanghai) Co., Ltd	Microchip Technology Thailand (HQ) (MTAI)				
		(ASSH)	(ASSH)					
Base Quantity	Tape and Reel	4000	4000	4000				
Multiple (BQM)	Tube	100	100	100				
	Tape and	Black	Black	Black				
Pin 1	Reel	See Pre and Post Change Summary for Comparison.						
Orientation	Tube	Quadrant 1	Quadrant 1	Quadrant 1				
	rube	See Pre and	Post Change Summary	<i>i</i> for Comparison.				
Carrie	r Tape	See Pre and	See Pre and Post Change Summary for Comparison.					
Cover	<sup>-</sup> Tape	See Pre and	Post Change Summary	<i>i</i> for Comparison.				
Plasti	c Reel	See Pre and	Post Change Summary	<i>i</i> for Comparison.				
Tube	Dimension	Minor dimensiona	Post Change Summary					
	Color	for Comparis		Clear				
Desiccant and HIC		See Pre and Post Change Summary for Comparison.						
Packing	Method	See Pre and Post Change Summary for Comparison.						

### Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve manufacturability by qualifying MTAI as an additional final test site.

**Change Implementation Status:**In Progress

Estimated First Ship Date: November 4, 2022 (date code: 2245)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### Time Table Summary:

	June 2022				>	Oc	tobe	er 20	22	N	love	mbe	r 202	22	
Morkwook	2	2	2	2	2		4	4	4	4	4	46	4	4	4
Workweek	2	3	4	5	6		1	2	3	4	5		7	8	9

Initial PCN Issue Date			Χ						
Qual Report Availability						Χ			
Final PCN Issue Date						Χ			
Estimated Implementation Date							Χ		

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** June 24, 2022: Issued initial notification.

October 27, 2022: Issued final notification. Updated affected CPN list to include catalog part numbers (CPN) released prior issuance of the Final PCN. Attached the qualification report and added estimated first ship date by November 04, 2022

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachments:

PCN\_CENO-21UTEV408 Pre\_and\_Post\_Change\_Summary.pdf PCN\_CENO-21UTEV408\_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for

Microchips PCN email service in the PCN FAQ section.
If you wish to <u>change your PCN profile</u> , <u>including opt out</u> , please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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#### Affected Catalog Part Numbers (CPN)

ATECC608B-SSHMD-B

ATECC608B-SSHCZ-B

ATECC608B-SSHDA-B

ATECC608A-SSHMD-B

ATECC108A-SSHDA-B

ATECC108A-SSHCZ-B

ATECC508A-SSHDA-B

ATECC508A-SSHCZ-B

ATECC508A-SSHHL-B

ATECC508A-SSHRA-B

ATECC508A-SSHMT-B

ATECC608A-SSHDA-B

ATECC608A-SSHCZ-B

ATECC608A-SSHHL-B

ATECC508A-SSH1P-T

ATECC608B-SSVDA-B

ATECC608B-SSVHL-T

ATECC608B-SSVDA-T

ATECC608B-SSHHL-T

ATECC108A-SSHDA-T

ATECC108A-SSHCZ-T

ATECC508A-SSHDA-T

ATECC508A-SSHCZ-T

ATECC508A-SSHHL-T

ATECC508A-SSHRA-T

ATECC508A-SSHMT-T

ATECC508A-SSHZC-T

ATECC508A-SSHZJ-T

ATECC508A-SSHAW-T

ATECC508A-SSHWA-T

ATECC508A-SSHC9-T ATECC608A-SSHDA-T

ATECC608A-SSHCZ-T

ATECC608A-SSHHL-T

ATECC608A-SSH4P-T

ATECC508A-SSH1F-T

ATECC508A-SSH1M-T

ATECC608A-SSH4N-T

ATECC508A-SSHC6-T

ATECC508A-SSH1L-T ATECC608A-SSH2P-T

ATECC608A-SSH3M-T

ATECC608B-SSH3S-T ATECC608B-SSHA5-T

ATECC608B-SSHA6-T

ATECC608B-SSHCZ-T

Date: Wednesday, October 26, 2022

CENO-21UTEV408 - CCB 5141 Final Notice: Qualification of MTAI as an additional final test site for selected ATECC108A-SSxxx-x, ATECC508A-SSxxx-x, ATECC508A-SSxxx-x, ATECC608B-SSxxx-x and ATSHA204A-SSxxx-x device families available in 8L SOIC (3.90mm) package.

ATECC608B-SSHDA-T

ATECC608A-SSHGA-T

ATECC608B-SSHKA-T

ATECC608A-SSHXA-T

ATSHA204A-SSHMD-B

ATSHA204A-SSHDA-B

ATSHA204A-SSH1S-B

ATSHA204A-SSHDA-T

ATSHA204A-SSHCZ-T

Date: Wednesday, October 26, 2022

# CCB 5141 Pre and Post Change Summary

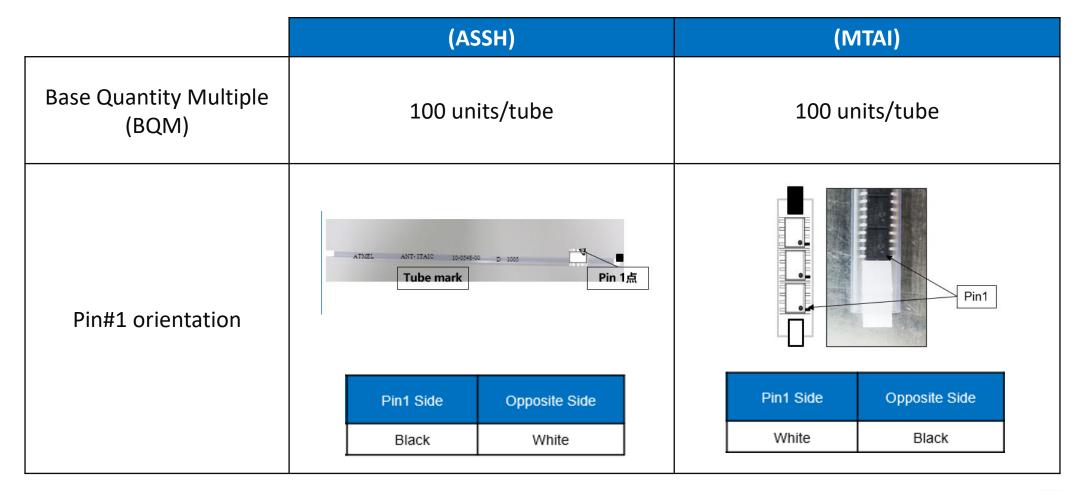
**PCN #: CENO-21UTEV408** 



A Leading Provider of Smart, Connected and Secure Embedded Control Solutions

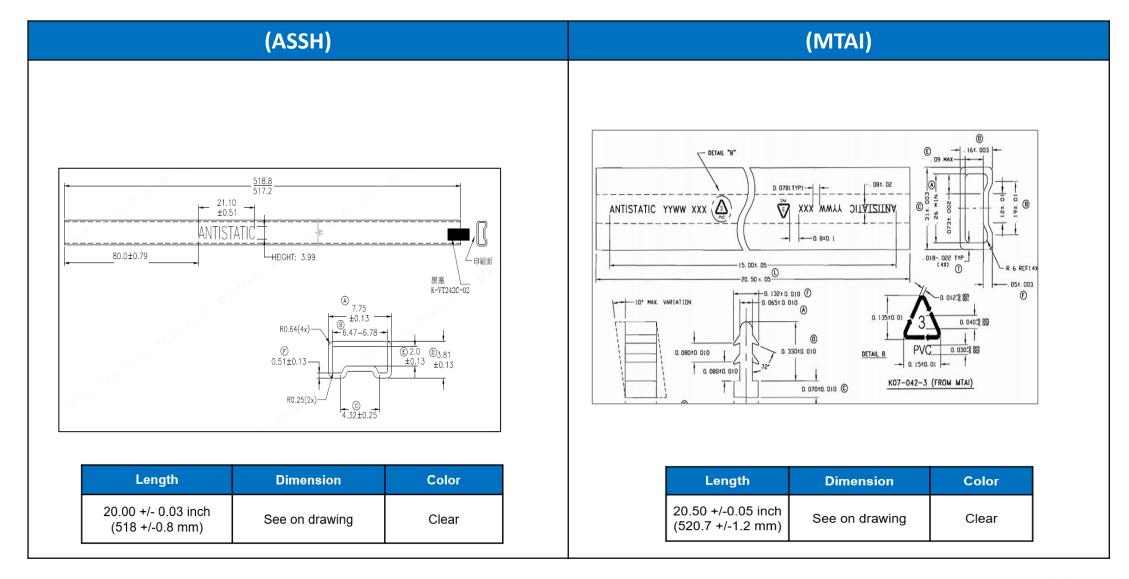


# **Tube – BQM and Pin 1 Orientation**





# **Tube - Drawing**



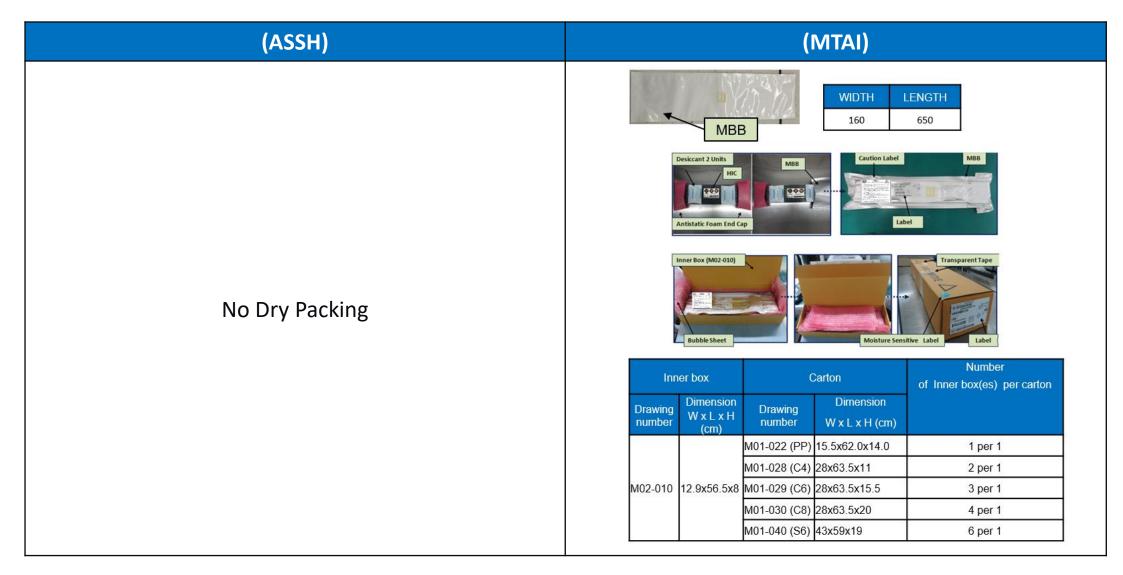


# **Tube - Non Dry Packing Method**



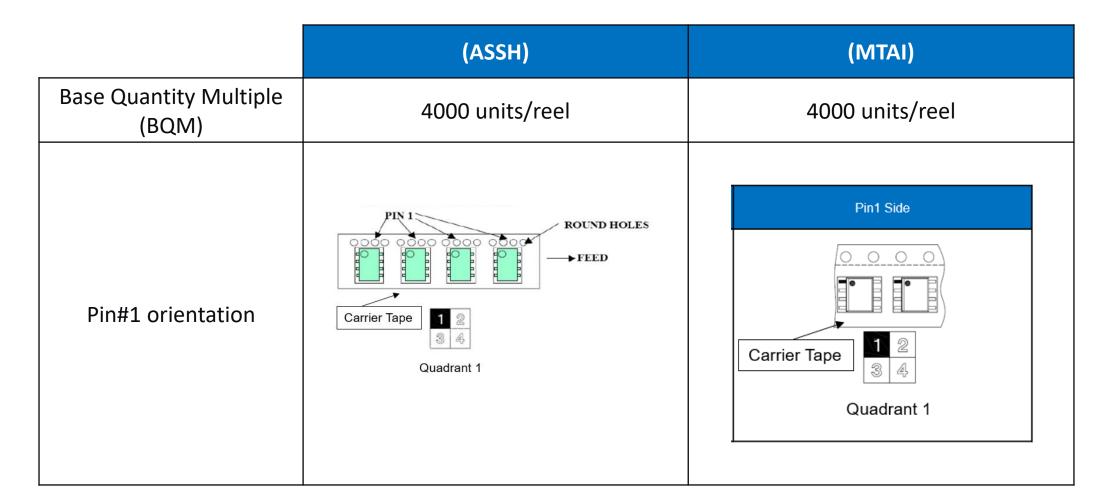


# **Tube - Dry Pack Packing Method**



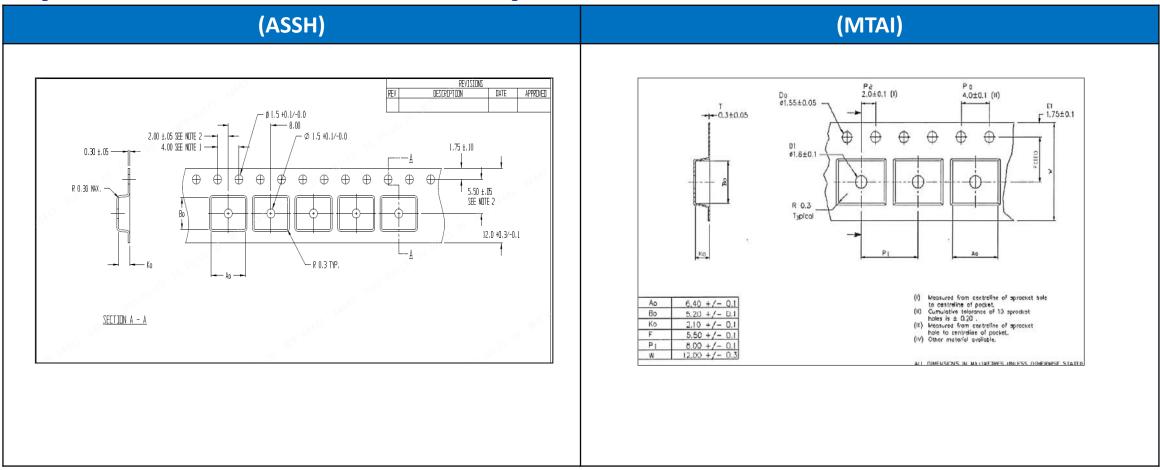


# Tape and Reel – BQM and Pin-1 Orientation





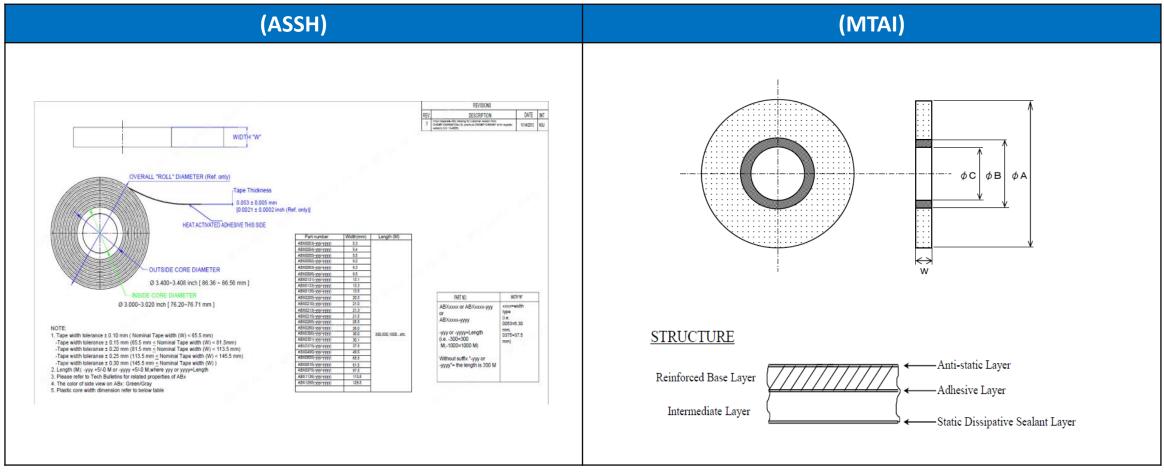
# **Tape and Reel – Carrier Tape**



Plant	W (mm.) ±0.3 or Specific	P (mm.) ±0.1 or Specific	A0 ±0.1 or Specific	B0 ±0.1 or Specific	K0 ±0.1 or Specific	Thickness
ASSH	12	8	6.40	5.20	2.10	-
MTAI	12	8	6.40	5.20	2.10	-



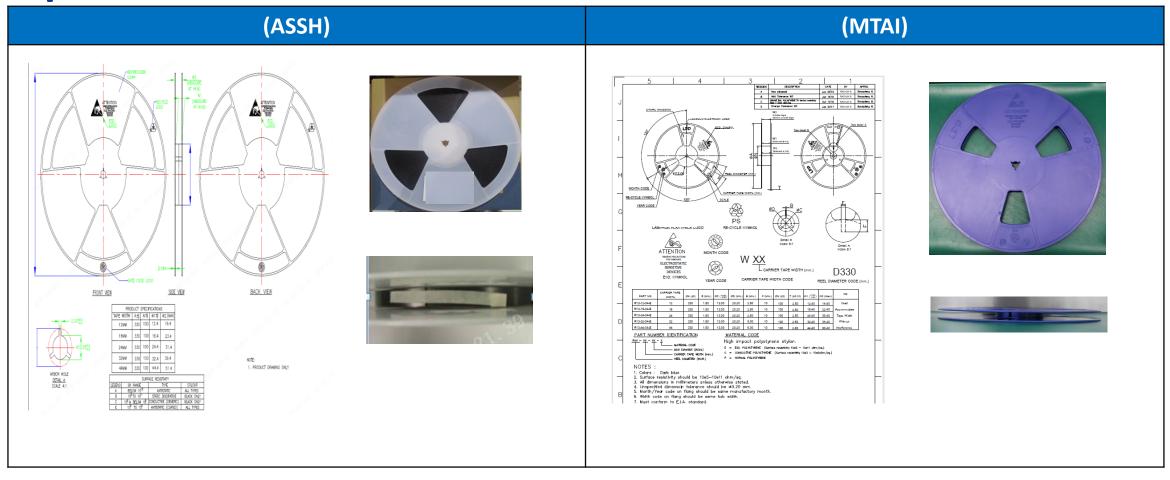
### **Tape and Reel – Cover Tape**



Plant	Carrier Width	Width "W" (mm)	Thickness (mm)	Sealing Mythology
ASSH	12mm	9.2+/-0.07	0.053 ±0.005	Heat seal
MTAI	12mm	9.05+0.05/-0.15	0.050 ±0.010	Heat seal



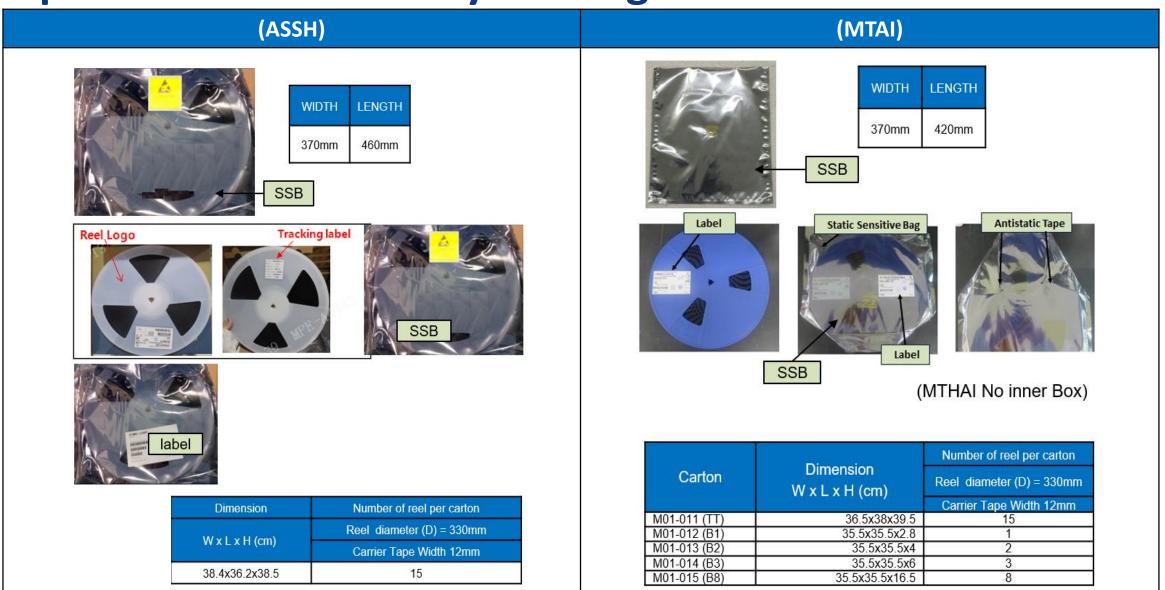
### Tape and Reel - Plastic Reel



Plant	Width	Hub	Color	
ASSH	12mm	4inch (100mm)	White	
MTAI	12mm	4inch (100mm)	Dark Blue	

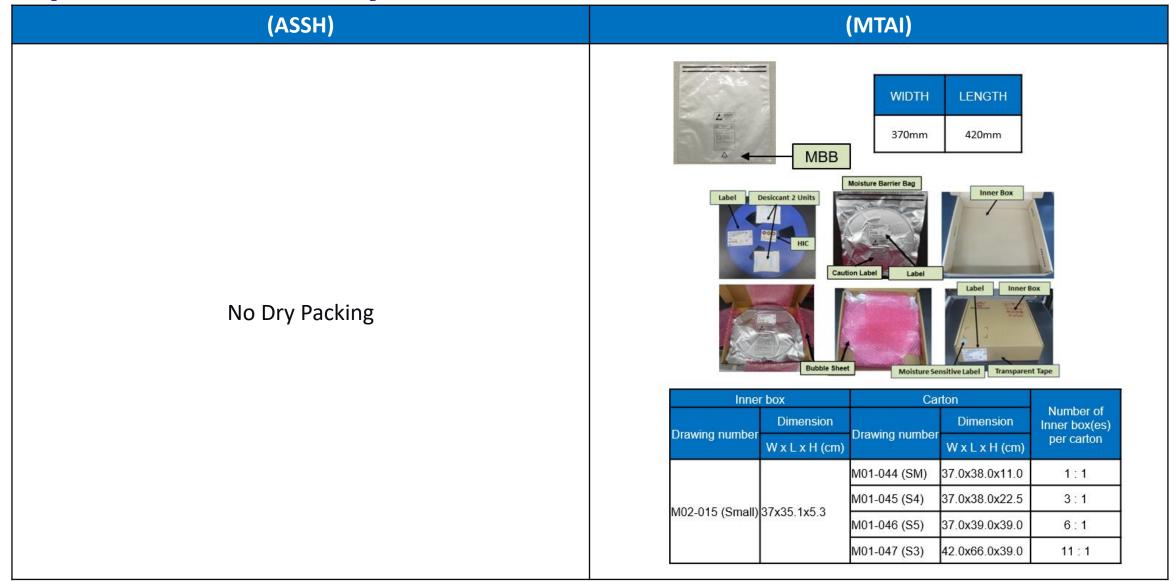


### Tape and Reel - Non-Dry Packing Method





### Tape and Reel –Dry Pack





### **Desiccant and HIC**

	(ASSH)	(MTAI)
Desiccant	No desiccant	SPECIFICATION MILE-D-SAME TYPE I II INTERCEPTION OF THE MINISTRUMENT WAS ARREST OF THE MINISTRUMENT OF THE
HIC	No HIC	60%  LEVEL 2 PARTS Bake parts if 60% IS NOT BROWN  Initial use:  DO NOT put this card into a bag If \$5%, 10% or 60% dots are AZURE   3 Dots  Cobalt free only





### QUALIFICATION REPORT SUMMARY RELIABILITY LABORATORY

**PCN #: CENO-21UTEV408** 

Date October 20, 2022

Qualification of MTAI as an additional final test site for selected ATECC108A-SSxxx-x, ATECC508A-SSxxx-x, ATECC608A-SSxxx-x, ATECC608B-SSxxx-x and ATSHA204A-SSxxx-x device families available in 8L SOIC (3.90mm) package.

**Purpose:** Qualification of MTAI as an additional final test site for selected ATECC108A-SSxxx-x, ATECC508A-SSxxx-x, ATECC608B-SSxxx-x and ATSHA204A-SSxxx-x device families available in 8L SOIC (3.90mm) package.

### **CCB#** 5141

Test	Parameters	Result
	Lot size is > 5K	
	100% test with FT for yield comparison	
Full Correlation	Acceptance: Accept 1% delta or PE/TE approval	PASSED
	Code verification, each die must be unique	